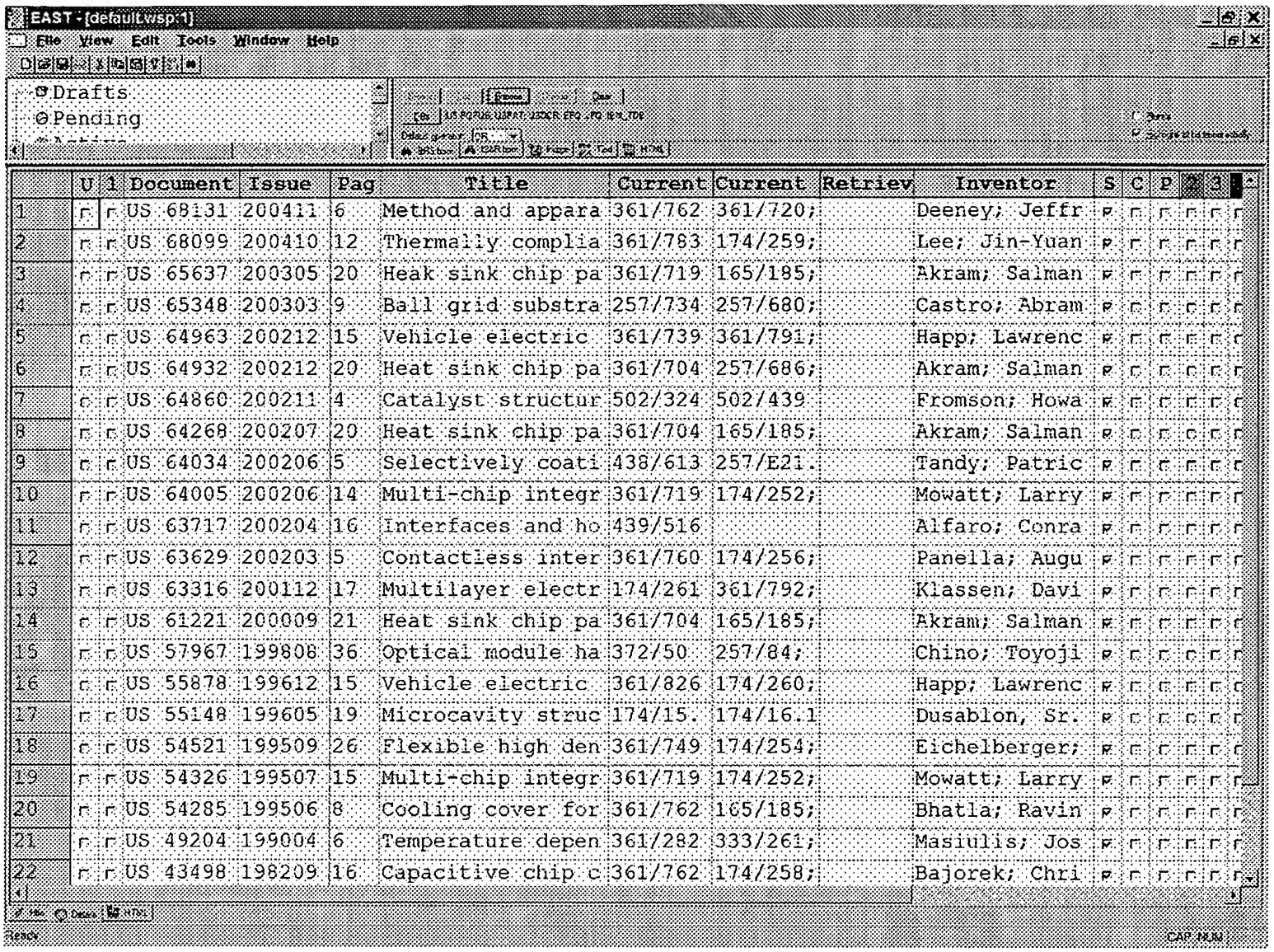

	U	1	Document	Issue	Pag	Title	Current	Current	Retriev	Inventor	S	C	P	2	3
1			US 68131	200411	6	Method and appara	361/762	361/720;		Deeney; Jeffr					
2			US 68099	200410	12	Thermally complia	361/783	174/259;		Lee; Jin-Yuan					
3			US 65637	200305	20	Heak sink chip pa	361/719	165/185;		Akram; Salman					
4			US 65348	200303	9	Ball grid substra	257/734	257/680;		Castro; Abram					
5			US 64963	200212	15	Vehicle electric	361/739	361/791;		Happ; Lawrenc					
6			US 64932	200212	20	Heat sink chip pa	361/704	257/686;		Akram; Salman					
7			US 64860	200211	4	Catalyst structur	502/324	502/439		Fromson; Howa					
8			US 64268	200207	20	Heat sink chip pa	361/704	165/185;		Akram; Salman					
9			US 64034	200206	5	Selectively coati	438/613	257/E21.		Tandy; Patric					
10			US 64005	200206	14	Multi-chip integr	361/719	174/252;		Mowatt; Larry					
11			US 63717	200204	16	Interfaces and ho	439/516			Alfaro; Conra					
12			US 63629	200203	5	Contactless inter	361/760	174/256;		Panella; Augu					
13			US 63316	200112	17	Multilayer electr	174/261	361/792;		Klassen; Davi					
14			US 61221	200009	21	Heat sink chip pa	361/704	165/185;		Akram; Salman					
15			US 57967	199808	36	Optical module ha	372/50	257/84;		Chino; Toyoji					
16			US 55878	199612	15	Vehicle electric	361/826	174/260;		Happ; Lawrenc					
17			US 55148	199605	19	Microcavity struc	174/15.	174/16.1		Dusablon, Sr.					
18			US 54521	199509	26	Flexible high den	361/749	174/254;		Eichelberger;					
19			US 54326	199507	15	Multi-chip integr	361/719	174/252;		Mowatt; Larry					
20			US 54285	199506	8	Cooling cover for	361/762	165/185;		Bhatla; Ravin					
21			US 49204	199004	6	Temperature depen	361/282	333/261;		Masiulis; Jos					
22			US 43498	198209	16	Capacitive chip c	361/762	174/258;		Bajorek; Chri					